# Miniature 0603 Size Thin-Film Fuses





### **ACCU-GUARD® TECHNOLOGY**

The new F0603G Accu-Guard® II low current fuses is based on thin-film technology which allows precise control of the component electrical and physical characteristics that is not possible with standard fuse technologies. The Accu-Guard II Low Current series encompasses the lowest current ratings in a 0603 package and features LGA terminations.

### **FEATURES**

- Accurate current rating
- Fast acting
- Standard 0603 chip size
- Color coded
- Taped and reeled
- RoHS compliant
- UL Approval: E141069

### **APPLICATIONS**

- Cellular Telephones
- Two-Way Radios
- Computers
- Battery Chargers
- Rechargeable Battery Packs
- Hard Disk Drives
- PDA's
- LCD Screens
- Digital and Video Cameras
- Instrumentation

### **ELECTRICAL SPECIFICATIONS**

Operating temperature: -55°C to +125°C

Current carrying capacity:

-55°C to -11°C 107% of rating

-10°C to +60°C 100% of rating

+61°C to +100°C 85% of rating

+101°C to +125°C 80% of rating

Rated voltage: 32V

Post-fusing resistance:  $>1M\Omega$ 

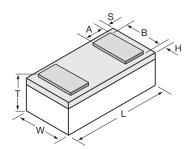
#### **TERMINATION**

Nickel/Solder coating compatible with automatic soldering technolgies: relow wave sodering, vapor phase and manual.

#### **ELECTRICAL PARAMETERS**

Part Number	Current Rating A	Resistance @0.1 x I <sub>RATED</sub> Ω (max.)	Voltage Drop @I <sub>RATED</sub> mV (max.)	Fusing Current (within 5 sec) A	Pre-Arc I <sup>2</sup> t @10xI <sub>RATED</sub> A <sup>2</sup> -sec (typ)	Color Code
F0603G0R05FNTR	0.050	3.4	250	0.125	2 x 10 <sup>-6</sup>	Blue
F0603G0R06FNTR	0.062	2.5	280	0.155	2 x 10 <sup>-6</sup>	Yellow
F0603G0R07FNTR	0.075	2.0	280	0.1875	4 x 10 <sup>-6</sup>	Brown
F0603G0R10FNTR	0.100	2.4	300	0.250	7 x 10 <sup>-6</sup>	Red
F0603G0R12FNTR	0.125	1.6	250	0.312	1 x 10 <sup>-5</sup>	White
F0603G0R15FNTR	0.150	1.2	220	0.375	2 x 10 <sup>-5</sup>	Green
F0603G0R20FNTR	0.200	0.8	210	0.500	4 x 10 <sup>-5</sup>	Pink

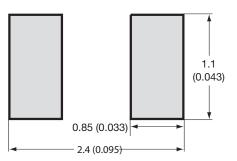
## **RECOMMEND PAD LAYOUT** millimeters (inches)



L	1.6±0.1 (0.063±0.004)
W	0.81±0.1 (0.063±0.004)
Т	0.61±0.1 (0.063±0.004)
Α	0.23±0.05 (0.063±0.002)
В	0.66±0.05 (0.063±0.002)
S, H	0.10±0.05 (0.063±0.002)

### **RECOMMEND PAD LAYOUT**

millimeters (inches)







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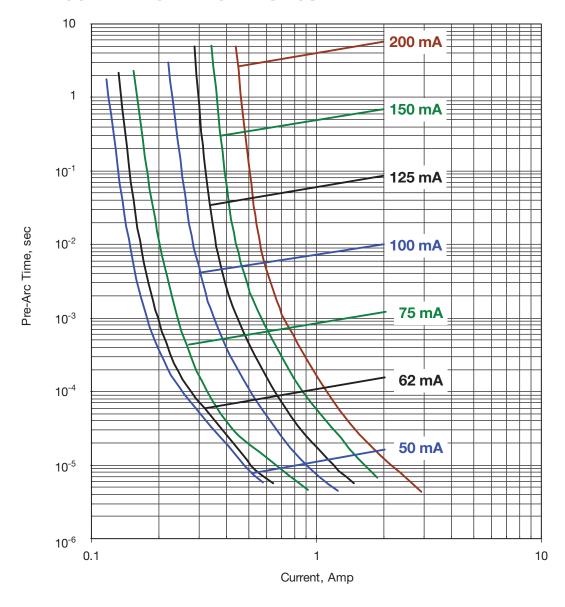
# **ENVIRONMENTAL CHARACTERISTICS**

Test	Conditions	Requirement		
Solderability	Components completely immersed in a	Total area of imperfections in solder coating		
	solder bath at 245 ±5°C for 3 secs.	up to 5% of the land suface area		
Leach Resistance	Components completely immersed in a solder	Dissolution of termination		
	bath at 255 ±5°C for 60 secs.	≤ 15% of the land surface area		
Storage	12 months minimum with components	Good solderability		
	stored in "as received" packaging.			
Shear	Components mounted to a substrate.	Destruction at 5N force minimum		
	Increasing shearing force applied paralled to			
	the sufstrate till destruction.			
Temperature	Components mounted to a flexible substrate	No Visible damage		
Cycling	(e.g. FR – 4). 1000 cycles -55°C to +125°C.	ΔR/R<10%		
Bend	Tested as shown in diagram	No visible damage		
		ΔR/R<10%		
	3 mm□ ↓			
	Deflection			
	45mm 45mm			
	<del></del>			



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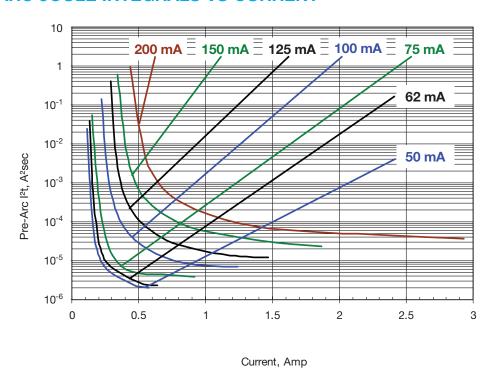
# **FUSE TIME - CURRENT CHARACTERISTICS**





# Miniature 0603 Size Thin-Film Fuses

## **FUSE PRE-ARC JOULE INTEGRALS VS CURRENT**



## **FUSE PRE-ARC JOULE INTEGRALS VS PRE-ARC TIME**

